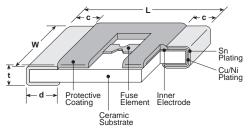




# thin film chip fuse



dimensions and construction



## ordering information

16**S** 

Size

10B: 1.0x0.5mm

16A: 1.6x0.8mm

16S: 1.6x0.8mm

Ν

Fusing Characteristic

N: Normal blow

T: Anti pulse (16A only)

TF

Туре

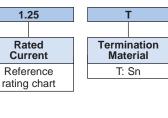


• Small, lightweight design

features

- Special manufacturing method stabilizing fusing characteristics and occupying less area
- Low power consumption and less voltage drop due to low internal resistance
- Suitable for overcurrent protection of circuit block in electronic devices
- · Suitable for flow and reflow soldering
- Products with lead-free terminations meet EU RoHS and China RoHS requirements

Туре	Dimensions inches (mm)					
(Inch Size Code)	L	W	С	d	t	
TF10BN	.04±.004	.02±.002	.008±.004	.01±.004	.015±.002	
(0402)	(1.0±0.1)	(0.5±0.05)	(0.2±0.1)	(0.25±0.1)	(0.4±0.05)	
TF16AT	.063±.004	.031±.003	.012±.004	.012±.004	.018±.002	
(0603)	(1.6±0.1)	(0.8±0.08)	(0.3±0.1)	(0.3±0.1)	(0.45±0.05)	
TF16SN	.063±.008	.031±.004	.012±.004	.012±.004	$.015+ +.004 \\002 \\ (0.4+ +0.1 \\ -0.05)$	
(0603)	(1.6±0.2)	(0.8±0.1)	(0.3±0.1)	(0.3±0.1)		



Packaging
TB: 2mm pitch punched paper (TF10BN only, 10,000 pieces/reel)
TD: 4mm pitch punched paper (TF16 only, 5,000 pieces/reel)

TE

## applications and ratings

Part Designation	Marking	Rated Current	Fusing Time	Internal R. Maximum (mΩ)	Rated Voltage	Rated Ambient Temperature	Operating Temperature Range
TF10BN0.20	А	0.20A		1990			
TF10BN0.25	С	0.25A		1270			
TF10BN0.315	D	0.315A		850			
TF10BN0.50	F	0.50A	Open within	320			
TF10BN0.63		0.63A	5 sec. at 200%	200		+70°C	-55°C to
TF10BN0.80	K	0.80A	rated current	135	32V		
TF10BN1.00	L	1.00A	(Refer to Fusing	115	32 V	+70 C	+125°C
TF10BN1.25	М	1.25A	Characteristics	90			+125 0
TF10BN1.60	Ν	1.60A	graph)	58			
TF10BN2.00	S	2.00A		42			
TF10BN2.50	Т	2.50A		35			
TF10BN3.00	V	3.00A		30			
TF16AT0.25	С	0.25A		498			
TF16AT0.315	D	0.315A		384			
TF16AT0.50	F	0.50A	Open within	198	32V +70°C	170°C	-55°C to +125°C
TF16AT0.63	I	0.63A	5 sec. at 200%	143			
TF16AT0.80	K	0.80A	rated current	120			
TF16AT1.00	Ĺ	1.00A	(Refer to Fusing	94		+/00	
TF16AT1.25	М	1.25A	Characteristics	73			T125 0
TF16AT1.60	Ν	1.60A	graph)	59			
TF16AT2.00	S	2.00A		42			
TF16AT2.50	Т	2.50A		32			
For further information on packaging, please refer to Appendix A.							

Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use. 12/01/17

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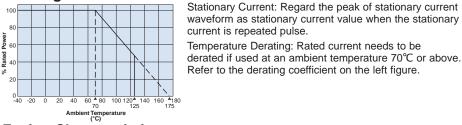
# thin film chip fuse

#### applications and ratings (continued)

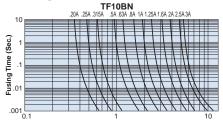
Part Designation	Marking	Rated Current	Fusing Time	Internal R. Maximum (mΩ)	Rated Voltage	Rated Ambient Temperature	Operating Temperature Range
TF16AT3.15	U	3.15A	Open within 5 sec. at	24			-55°C
TF16AT4.00	Х	4.00A	200% rated current (Refer to Fusing	17	32V	+70°C	to
TF16AT5.00	Y	5.00A	Characteristics graph)	14			+125°C
TF16SN0.20	А	0.20A		1500			
TF16SN0.25	С	0.25A		960			
TF16SN0.315	D	0.315A		600			
TF16SN0.40	Н	0.40A	Open within	440			
TF16SN0.50	F	0.50A	1 sec. at 200%	300			_
TF16SN0.63		0.63A	rated current	190			-40°C
TF16SN0.70	J	0.70A	(Refer to Fusing	170	32V	+70°C	to +125°C
TF16SN0.80	K	0.80A	Characteristics	135			+12516
TF16SN1.00	L	1.00A		103			
TF16SN1.25	М	1.25A	graph)	78			
TF16SN1.60	Ν	1.60A		58			
TF16SN2.00	S	2.00A		47			
TF16SN2.50	Т	2.50A		38			
TF16SN3.15	U	3.15A		28			

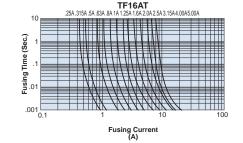
### environmental applications

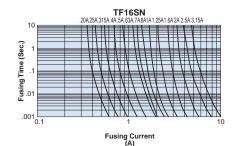
#### **Derating Curve**



#### **Fusing Characteristics**







#### **Performance Characteristics**

Fusing Current (A)

	Require	ement			
Parameter	Limit	Typical	Test Method		
Fusing Characteristics	Within 1 second (16SN) Within 5 seconds (10BN, 16AT)	_	200% of rated voltage shall be carried (@25°C)		
Bending Test	No mechanical damages	_	Distance between holding points: 90mm, Bending: 3mm, 1 time (BN, AT), 2mm, 1 time (SN)		
Resistance to Solder Heat	±10%	±4.5% (16SN) ±5% (10BN, 16AT)	$260^{\circ}\text{C} \pm 5^{\circ}\text{C}$ , 10 seconds $\pm 0.5^{\text{4}}$ second		
Solderability	95% coverage minimum	—	$245^{\circ}C \pm 3^{\circ}C$ , 3 seconds $\pm 0.5$ second		
Load Life	±10%	±4.5%(16SN) ±5% (10BN, 16AT)	$70^{\circ}C \pm 2^{\circ}C$ , 1000 hours, rated current x 100%, 1.5 hr ON, 0.5 hr OFF cycle		
Load Life Moisture	±10%	±3% (10BN) ±4.5% (16SN), 5% (16AT)	40°C ± 2°C, 90 - 95% RH, 1000 hours, rated current x 100% (10BN, 16SN), x 75% (16AT), 1.5 hr ON, 0.5 hr OFF cycle		
Rapid Change of Temperature	±10%	±4% (16SN) ±5% (10BN, 16AT)	16SN: -40°C ± 2°C (30 minutes), 10BN, 16AT: -55°C ± 2°C, +125°C (30 minutes), 10 cycles		
Resistance to Solvent	No evidence of damages to protective coating and marking	_	Conforming to MIL-STD-202F		
Residual Resistance	$10k\Omega$ and more	_	Measure DC resistance after fusing		
Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use. 12/19/17					



protect

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